# 506524466 02/25/2021 PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6571241

SUBMISSION TYPE:			NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		SECOND LIEN TERMINATION AND RELEASE OF SECURITY INTEREST IN PATENTS			
CONVEYING PARTY	DATA				
			Name		Execution Date
BARCLAYS BANK PLC, AS COLLAT			RAL AGENT		02/25/2021
RECEIVING PARTY	ΟΑΤΑ				
Name: OPTIMIM L			C (F/K/A KINETICS DYNACAST	, INC.)	
Street Address:	11325	NORT	H COMMUNITY HOUSE ROAD	, SUITE 3	300
City:	CHAR	LOTTE	E		
State/Country:	,		ROLINA		
Postal Code:	28277				
PROPERTY NUMBER	RS Total: 2	2			
Property Typ	е		Number		
Patent Number:788					
		78826	601		
Application Number:		78826 13184		_	
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#### SECOND LIEN TERMINATION AND RELEASE OF SECURITY INTEREST IN PATENTS

This SECOND LIEN TERMINATION AND RELEASE OF SECURITY INTEREST IN PATENTS (this "<u>Termination and Release</u>"), dated as of February 25, 2021, from Barclays Bank PLC, in its capacity as administrative agent and collateral agent (the "<u>Agent</u>") for the banks and other financial institutions that are parties to the Second Lien Credit Agreement, dated as of January 30, 2015, as amended, supplemented or otherwise modified from time to time, among Form Technologies LLC, a Delaware limited liability company (f/k/a Dynacast International LLC) (the "<u>Borrower</u>"), Form Technologies, Inc., a Delaware limited liability corporation (f/k/a Dynacast International Inc.) ("<u>Holdings</u>"), the Agent, as administrative agent and collateral agent and the other parties thereto, to each of the Grantors listed on <u>Schedule A</u> hereto (together, the "<u>Grantors</u>" and each, a "<u>Grantor</u>"). Capitalized terms used herein without definition are used as defined in the Second Lien Security Agreement (as defined below).

#### WITNESSETH:

WHEREAS, pursuant to that certain Second Lien Security Agreement, dated as of January 30, 2015, as amended, supplemented or otherwise modified from time to time (the "<u>Second Lien Security Agreement</u>"), made by the Borrower, Holdings and the Grantors in favor of the Agent, each Grantor granted to the Agent, for the benefit of the Secured Parties, a security interest (the "<u>Security Interest</u>") in certain Collateral, including all of such Grantor's Patents and the proceeds and products of such Patents (such Patents, proceeds, products, rents and profits of each Grantor, collectively, the "<u>Patent Collateral</u>"), as collateral security for the prompt and complete payment and performance when due of the Obligations of such Grantor;

WHEREAS, in connection with the Second Lien Security Agreement, the Grantors and the Agent entered into the Patent Security Agreements listed on <u>Schedule B</u> hereto, each of which was recorded in the United States Patent and Trademark Office on the date and at the Reel/Frame specified in <u>Schedule B</u> hereto; and

WHEREAS, the Grantors request that the Agent terminate and release its Security Interest in the Patent Collateral.

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which are hereby acknowledged, and upon the terms set forth in this Termination and Release, the Agent hereby states as follows:

1. <u>Termination and Release of Security Interest</u>. The Agent hereby, without representation, warranty or recourse of any kind, terminates, releases and discharges its Security Interest in the Patent Collateral (including, without limitation, any rights granted under the Patent Security Agreements listed on <u>Schedule B</u> hereto and those items listed on <u>Schedule C</u> and <u>Schedule D</u> hereto), and any right, title or interest of the Agent in such Patent Collateral shall hereby cease and become void.

2. <u>Further Assurances</u>. The Agent agrees to duly execute and deliver to the Grantors all further releases and other documents (including, without limitation, Uniform Commercial

Code termination statements), and take all other actions as a Grantor may reasonably request in writing, all at such Grantor's sole cost and expense, for the purpose of obtaining the release of the Security Interest contemplated under this Termination and Release.

3. <u>Governing Law</u>. This Termination and Release shall be governed by, and construed in accordance with, the laws of the State of New York.

\* \* \*

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IN WITNESS WHEREOF, the undersigned has executed this Termination and Release by its duly authorized officer as of the date first above written.

BARCLAYS BANK PLC, as the Agent

~DocuSigned by: Robert Walsh Name: Robert Walsh By:

Name: Robert Walsh Title: Assistant Vice President

[SIGNATURE PAGE – SECOND LIEN TERMINATION AND RELEASE OF SECURITY INTEREST IN PATENTS]

PATENT REEL: 055419 FRAME: 0295

# SCHEDULE A

#### GRANTORS

- 1. Signicast LLC
- 2. Optimim LLC (f/k/a Kinetics Dynacast, Inc.)

# SCHEDULE B PATENT SECURITY AGREEMENTS

Patent Security Agreement	<u>Reel/Frame</u>	Recordation Date
1. Patent Security Agreement, dated as of January 30, 2015, made by OPTIMIM LLC (f/k/a KINETICS DYNACAST, INC.) in favor of BARCLAYS BANK PLC	034871/0435	02/02/2015
2. Patent Security Agreement, dated as of March 31, 2017, made by SIGNICAST LLC in favor of BARCLAYS BANK PLC	042165/0713	04/05/2017

### SCHEDULE C

## PATENTS PLEDGED PER REEL 034871/0435, FEBRUARY 2, 2015

#### **US Patents Issued:**

Patent Number	Issue Date	Title	Inventor(s)
7,882,601	2/8/2011	Snap Clip Lug	Khanh Phu Nguyen

#### **US Patents Pending:**

Date Filed	Application Number	Title	Jurisdiction
7/18/11	13/184,714 (2012/0015204)	Stainless Steel Alloy	United States

## SCHEDULE D

#### PATENTS PLEDGED PER REEL 042165/0713, APRIL 5, 2017

#### **US Patents Issued:**

Patent Number	Issue Date	Title	Inventor(s)
10,010,930	7/3/2018	Wax Mold for Investment	James Okonek, Brian
		Casting and Methods of	Alan Williams
		Assembling a Wax Mold	

# **US Patents Pending:**

None.

#94201656v3

**RECORDED: 02/25/2021**